

# FCP190N60\_GF102 N-Channel SuperFET<sup>®</sup> II MOSFET

600 V, 20.2 A, 199 m $\Omega$ 

## Features

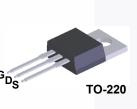
- 650 V @ T<sub>J</sub> = 150°C
- Typ. R<sub>DS(on)</sub> = 170 mΩ
- Ultra Low Gate Charge (Typ. Q<sub>q</sub> = 57 nC)
- Low Effective Output Capacitance (Typ. Coss(eff.) = 160 pF)
- 100% Avalanche Tested
- RoHS Compliant

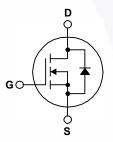
## Application

- LCD / LED / PDP TV Lighting
- Solar Inverter
- AC-DC Power Supply

## Description

SuperFET<sup>®</sup> II MOSFET is Fairchild Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This technology is tailored to minimize conduction loss, provide superior switching performance, dv/dt rate and higher avalanche energy. Consequently, SuperFET II MOSFET is very suitable for the switching power applications such as PFC, server/telecom power, FPD TV power, ATX power and industrial power applications.





### Absolute Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted.

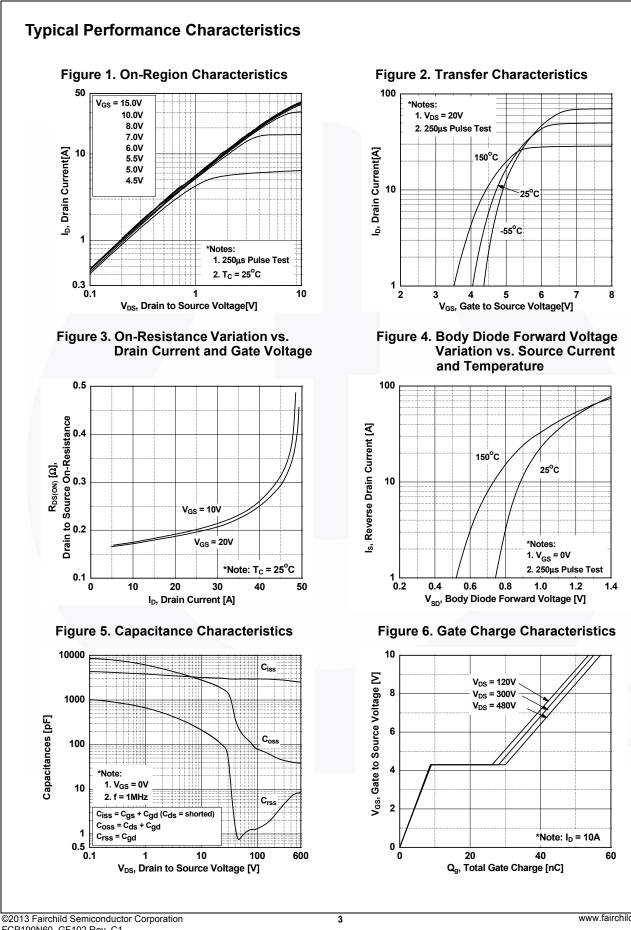
| Symbol                            |  | FCP190N60_GF102                                   | Unit   |             |      |
|-----------------------------------|--|---|--|-------------|------|
| V <sub>DSS</sub>                  | Drain to Source Voltage  | 600   | V  |             |      |
| V <sub>GSS</sub>                  |  | - DC  | - DC   |             | V    |
|                                   | Gate to Source Voltage   | - AC  | - AC (f > 1 Hz)                                |             |      |
| ID                                | Decia Company  | - Continuous (T <sub>C</sub> = 25 <sup>o</sup> C) | 20.2   | •           |      |
|                                   | Drain Current  | - Continuous ( $T_c = 100^{\circ}C$ )             |  | 12.7        | A    |
| I <sub>DM</sub>                   | Drain Current  | - Pulsed  | (Note 1)                                       | 60.6        | А    |
| E <sub>AS</sub>                   | Single Pulsed Avalanche En   | 400   | mJ   |             |      |
| I <sub>AR</sub>                   | Avalanche Current  | (Note 1)  | 4.0  | А           |      |
| E <sub>AR</sub>                   | Repetitive Avalanche Energy  | 2.1   | mJ   |             |      |
| dv/dt                             | MOSFET dv/dt   | 100   | V/ns   |             |      |
|                                   | Peak Diode Recovery dv/dt  | 20  |  |             |      |
| P <sub>D</sub>                    | Dower Dissinction  | (T <sub>C</sub> = 25°C)                           | (T <sub>C</sub> = 25°C)<br>- Derate Above 25°C |             | W    |
|                                   | Power Dissipation  | - Derate Above 25°C                               |  |             | W/ºC |
| T <sub>J</sub> , T <sub>STG</sub> | Operating and Storage Temperature Range                              |   |  | -55 to +150 | °C   |
| TL                                | Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds |   |  | 300         | °C   |

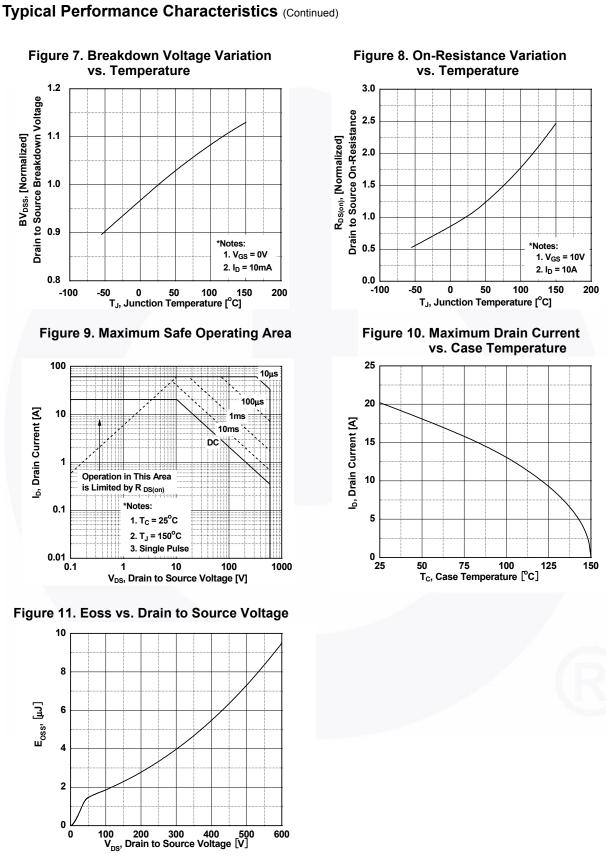
## **Thermal Characteristics**

| Symbol                | Parameter                                     | FCP190N60_GF102 | Unit  |  |
|-----------------------|---|-----------------|-------|--|
| $R_{	extsf{	heta}JC}$ | Thermal Resistance, Junction to Case, Max.    | 0.6             | °C/W  |  |
| $R_{	extsf{	heta}JA}$ | Thermal Resistance, Junction to Ambient, Max. | 62.5            | -0/00 |  |

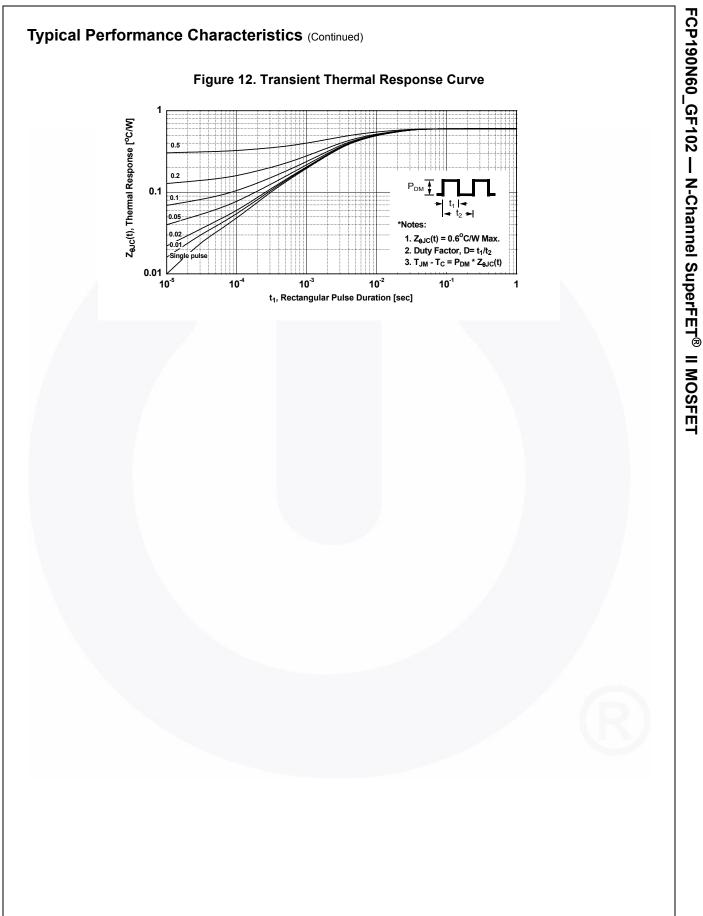
| FCP190N60_            |
|-----------------------|
| GF102 —               |
| N-Channel S           |
| SuperFET <sup>®</sup> |
| <b>II MOSFET</b>      |

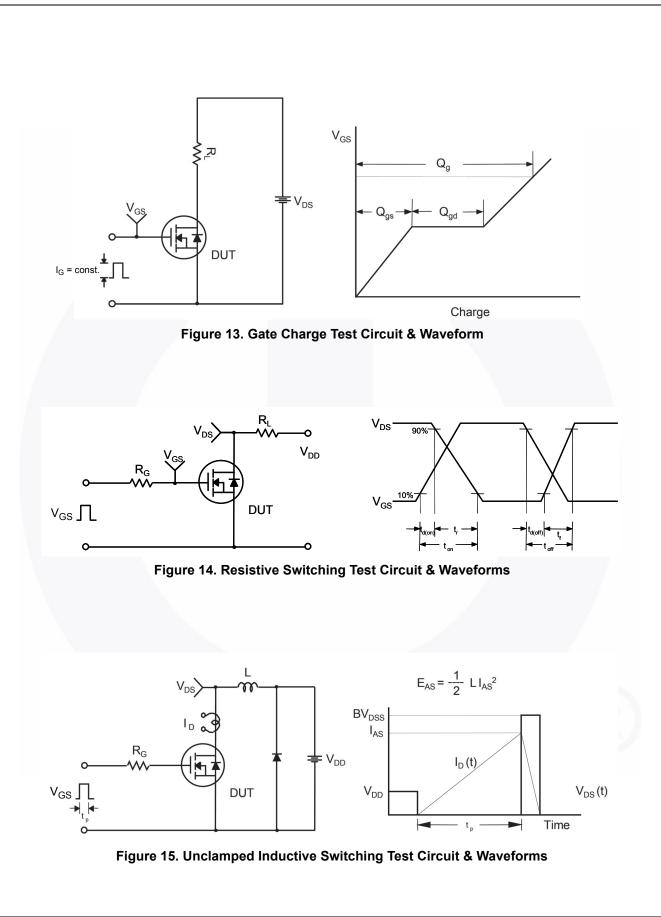
|   | nber                                  | Top Mark                                  | Packag     | e Packing Meth   | nod Reel Siz | e .  | Tape Width | Qu       | antity |
|---|---------------------------------------|---|------------|--|--------------|------|------------|----------|--------|
| FCP190N60   | •                                     |   | TO-220     | ) Tube   | N/A          |      | N/A        | 50 units |        |
| Electrica   | l Char                                | acteristics T <sub>c</sub> = :            | 25ºC unles | ss otherwise noted.  |              |      |            |          |        |
| Symbol  |                                       | Parameter                                 |            | Test Con   | ditions      | Min. | Тур.       | Max.     | Unit   |
| Off Charac  | teristic                              | s   |            |  |              | 1    |            |          | 1      |
|   |                                       |   |            | V <sub>GS</sub> = 0 V, I <sub>D</sub> = 10 mA, T <sub>J</sub> = 25°C   |              | 600  | -          | -        | - V    |
| BV <sub>DSS</sub>                                     | Drain to                              | ain to Source Breakdown Voltage           |            | $V_{GS} = 0 V, I_D = 10 mA, T_J = 150^{\circ}C$  |              | 650  | -          | -        |        |
| ΔBV <sub>DSS</sub><br>/ ΔT <sub>.I</sub>              |                                       | Breakdown Voltage Temperature             |            | $I_D = 10 \text{ mA}, \text{ Referenced to } 25^{\circ}\text{C}$   |              | -    | 0.67       | -        | V/ºC   |
| BV <sub>DS</sub>                                      |                                       | Drain to Source Avalanche Breakdown       |            | V <sub>GS</sub> = 0 V, I <sub>D</sub> = 20 A   |              | -    | 700        | -        | v      |
|   |                                       |   |            | V <sub>DS</sub> = 480 V, V <sub>GS</sub> =   | = 0 V        | -    | -          | 1        | +      |
| I <sub>DSS</sub>                                      | Zero Ga                               | ate Voltage Drain Curre                   | nt         | $V_{DS} = 480 \text{ V}, \text{ T}_{C} = 2000 \text{ C}$   |              | -    | -          | 10       | μA     |
| I <sub>GSS</sub>                                      | Gate to                               | Body Leakage Current                      |            | $V_{GS} = \pm 20 \text{ V}, \text{ V}_{DS} =$  |              | -    | -          | ±100     | nA     |
| On Charac   | teristic                              | S   |            |  |              |      |            |          |        |
| V <sub>GS(th)</sub>                                   | Gate Th                               | nreshold Voltage                          |            | V <sub>GS</sub> = V <sub>DS</sub> , I <sub>D</sub> = 250   | ) μΑ         | 2.5  | -          | 3.5      | V      |
| R <sub>DS(on)</sub>                                   |                                       | tic Drain to Source On Resistance         |            | $V_{GS} = 10 \text{ V}, \text{ I}_{D} = 10 \text{ A}$  |              |      | 0.17       | 0.199    | Ω      |
| 9 <sub>FS</sub>                                       | Forward                               | Forward Transconductance                  |            | V <sub>DS</sub> = 20 V, I <sub>D</sub> = 10  |              | -    | 21         | -        | S      |
| Dynamic C   | haracte                               | eristics                                  |            |  |              |      |            |          |        |
| C <sub>iss</sub>                                      | 1                                     | apacitance                                |            | V <sub>DS</sub> = 25 V, V <sub>GS</sub> = 0 V,<br>f = 1 MHz  |              |      | 2220       | 2950     | pF     |
| C <sub>oss</sub>                                      |                                       | Capacitance                               |            |  |              | -    | 1630       | 2165     | pF     |
| C <sub>rss</sub>                                      | -                                     | e Transfer Capacitance                    |            |  |              | -    | 85         | 128      | pF     |
| C <sub>oss</sub>                                      | Output                                | utput Capacitance                         |            | $V_{DS} = 380 \text{ V}, V_{GS} = 0 \text{ V}, \text{f} = 1 \text{ MHz}$<br>$V_{DS} = 0 \text{ V} \text{ to } 480 \text{ V}, V_{GS} = 0 \text{ V}$ |              | -    | 42         | -        | pF     |
| C <sub>oss(eff.)</sub>                                | Effective Output Capacitance          |   |            |  |              | -    | 160        | -        | pF     |
| Q <sub>g(tot)</sub>                                   | Total Ga                              | ate Charge at 10V                         |            | $V_{DS} = 380 \text{ V}, \text{ I}_{D} = 10 \text{ A},$<br>$V_{GS} = 10 \text{ V}$ (Note 4)  |              | -    | 57         | 74       | nC     |
| Q <sub>gs</sub>                                       | Gate to                               | Source Gate Charge                        |            |  |              | -    | 9          | -        | nC     |
| Q <sub>gd</sub>                                       | Gate to                               | Drain "Miller" Charge                     |            |  |              | -    | 21         | -        | nC     |
| ESR   | Equivalent Series Resistance          |   |            | f = 1 MHz  |              | -    | 1          | -        | Ω      |
| Switching   | Charac                                | teristics                                 |            |  |              |      |            |          |        |
| t <sub>d(on)</sub>                                    | Turn-Or                               | n Delay Time                              |            |  |              | -    | 20         | 50       | ns     |
| t <sub>r</sub>  | Turn-Or                               | n Rise Time                               |            | V <sub>DD</sub> = 380 V, I <sub>D</sub> = 10 A,  |              | -    | 10         | 30       | ns     |
| t <sub>d(off)</sub>                                   | Turn-Of                               | Turn-Off Delay Time<br>Turn-Off Fall Time |            | V <sub>GS</sub> = 10 V, R <sub>g</sub> = 4   | -            | 64   | 138        | ns       |        |
| t <sub>f</sub>  | Turn-Of                               |   |            | (Note 4)   |              | -    | 5          | 20       | ns     |
| Drain-Sour  | ce Dio                                | de Characteristics                        | 5          |  |              |      |            |          |        |
| I <sub>S</sub>  | Maximu                                | m Continuous Drain to                     | Source Die | ode Forward Current  |              | -    | -          | 20.2     | Α      |
|   |                                       | m Pulsed Drain to Sour                    |            |  |              | -    | -          | 60.6     | Α      |
| I <sub>SM</sub>                                       | Drain to Source Diode Forward Voltage |   | Voltage    | V <sub>GS</sub> = 0 V, I <sub>SD</sub> = 10 A  |              | -    | -          | 1.2      | V      |
| I <sub>SM</sub><br>V <sub>SD</sub>                    |                                       | Boower, Time                              |            | $V_{GS} = 0, I_{SD} = 10 \text{ A},$<br>$d_{I_F}/dt = 100 \text{ A}/\mu\text{s}$   |              | -    | 280        | -        | ns     |
| I <sub>SM</sub><br>V <sub>SD</sub><br>t <sub>rr</sub> | Reverse                               | e Recovery Time                           |            |  |              |      |            |          |        |



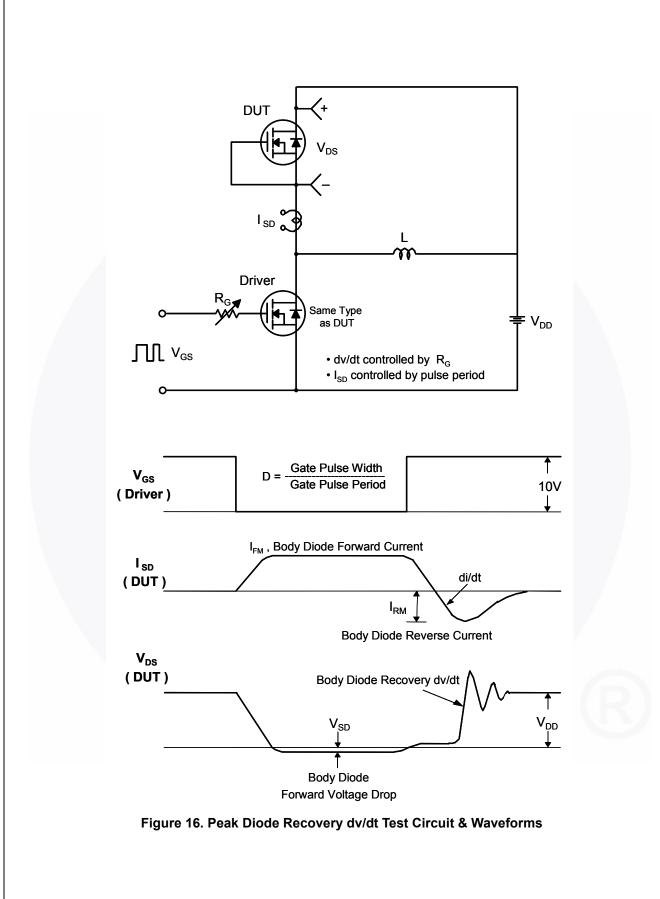


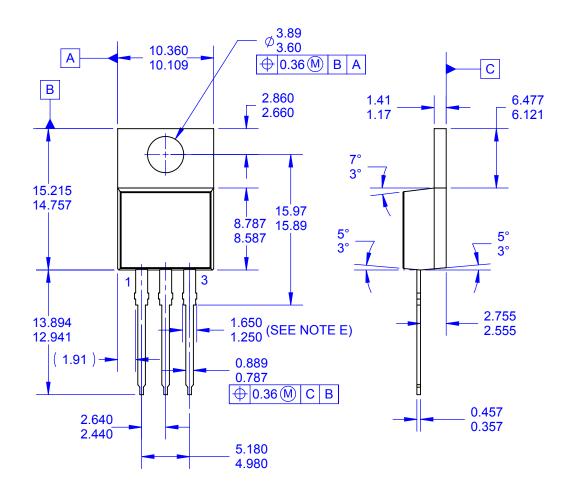
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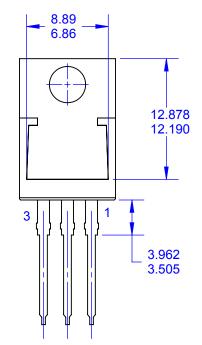


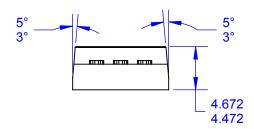


FCP190N60\_GF102 — N-Channel SuperFET<sup>®</sup> II MOSFET









NOTES:

- A. PACKAGE REFERENCE: JEDEC TO220 VARIATION AB
- B. ALL DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSION AND TOLERANCE AS PER ASME Y14.5-2009.
- D. DIMENSIONS ARE EXCLUSIVE OF BURRS,
  - MOLD FLASH AND TIE BAR PROTRUSIÓNS.
- E. MAX WIDTH FOR F102 DEVICE = 1.35mm. F. DRAWING FILE NAME: TO220T03REV4.
- G. FAIRCHILD SEMICONDUCTOR.



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